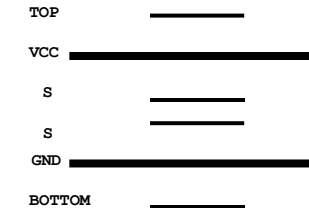


Project code: 91.4X101.001
PCB P/N : 48.4X101.011
REVISION : 07220-1

PCB STACKUP

RTM

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title			
BLOCK DIAGRAM			
Size A3	Document Number		Rev
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Date:	Thursday, July 05, 2007	Sheet 1 of	36

ICH8M Functional Strap Definitions

ICH8-M EDS 21762 2.0V1 page 16

Signal	Usage/When Sampled	Comment
HDA_SDOUT	XOR Chain Entrance/ PCIE Port Config1 bit1, Rising Edge of PWROK	Allows entrance to XOR Chain testing when TP3 pulled low.When TP3 not pulled low at rising edge of PWROK,sets bit1 of RPC.PC(Config Registers: offset 224h)
HDA_SYNC	PCIE config1 bit0, Rising Edge of PWROK.	This signal has a weak internal pull-down. Sets bit0 of RPC.PC(Config Registers:Offset 224h)
GNT2#	PCIE config2 bit0, Rising Edge of PWROK.	This signal has a weak internal pull-up. Sets bit2 of RPC.PC2(Config Registers:Offset 0224h)
GPIO20	Reserved	This signal should not be pulled high.
GNT1#/ GPIO51	ESI Strap (Server Only) Rising Edge of PWROK	ESI compatible mode is for server platforms only. This signal should not be pulled low for desttop and mobile.
GNT3#	Top-Block Swap Override. Rising Edge of PWROK.	Sampled low:Top-Block Swap mode(inverts A16 for all cycles targeting FWH BIOS space). Note: Software will not be able to clear the Top-Swap bit until the system is rebooted without GNT3# being pulled down.
GNT0#/ SPI_CS1#	Boot BIOS Destination Selection. Rising Edge of PWROK.	Controllable via Boot BIOS Destination bit (Config Registers:Offset 3410h:bit 11:10). GNT0# is MSB, 01-SPI, 10-PCI, 11-LPC.
INTVRMEN	Integrated VccSus1_05, VccSus1_5 and VccCL1_5 VRM Enable/Disable. Always sampled.	Enables integrated VccSus1_05, VccSus1_5 and VccCL1_5 VRM's when sampled high
LAN100_SLP	Integrated VccLAN1_05 and VccCL1_05 VRM Enable/Disable. Always sampled.	Enables integrated VccLAN1_05 and VccCL1_05 VRM's when sampled high
SATALED#	PCI Express Lane Reversal. Rising Edge of PWROK.	Signal has weak internal pull-up. Sets bit 27 of MPC.LR(Device 28:Function 0:Offset D8)
SPKR	No Reboot. Rising Edge of PWROK.	If sampled high, the system is strapped to the "No Reboot" mode(ICH8 will disable the TCO Timer system reboot feature). The status is readable via the NO REBOOT bit.
TP3	XOR Chain Entrance. Rising Edge of PWROK.	This signal should not be pull low unless using XOR Chain testing.
GPIO33/ HDA_DOCK _EN#	Flash Descriptor Security Override Strap Rising Edge of PWROK	This signal has a weak internal pull-up. Sampled low:the Flash Descriptor Security will be overridden. If high,the security measures will be in effect.This should only be used in manufacturing environments.

ICH8M IDE Integrated Series
Termination Resistors

DD[15:0], DIOW#, DIOR#, DREQ, DDACK#, IORDY, DA[2:0], DCS1#, DCS3#, IDEIRQ	approximately 33 ohm
--	----------------------

PCIE Routing

LANE1	LAN Marvell
LANE2	MiniCard WLAN
LANE3	NewCard WLAN

USB Table

USB	
Pair	Device
0	USB1
1	NC
2	USB2
3	NC
4	USB3
5	NC
6	NC
7	MINICARD
8	CCD
9	NEW1

ICH8M Integrated Pull-up
and Pull-down Resistors

ICH8-M EDS 21762 2.0V1

SIGNAL	Resistor Type/Value
HDA_BIT_CLK	PULL-DOWN 20K
HDA_RST#	NONE
HDA_SDIN[3:0]	PULL-DOWN 20K
HDA_SDOUT	PULL-DOWN 20K
HDA_SYNC	PULL-DOWN 20K
GNT[3:0]	PULL-UP 20K
GPIO[20]	PULL-DOWN 20K ?
LDA[3:0]#/FWH[3:0]#	PULL-UP 20K
LAN_RXD[2:0]	PULL-UP 10K
LDRQ[0]	PULL-UP 20K
LDRQ[1]/GPIO23	PULL-UP 20K
PME#	PULL-UP 20K
PWRBTN#	PULL-UP 20K
SATALED#	PULL-UP 15K
SPI_CS1#	PULL-UP 20K
SPI_CLK	PULL-UP 20K
SPI_MOSI	PULL-UP 20K
SPI_MISO	PULL-UP 20K
TACH_[3:0]	PULL-UP 20K ?
SPKR	PULL-DOWN 20K
TP[3]	PULL-UP 20K
USB[9:0][P,N]	PULL-DOWN 15K
CL_RST#	PULL-UP 13K

Crestline Strapping Signals and
Configuration

Crestline EDS 20954 1.0
page 7

Pin Name	Strap Description	Configuration
CFG[2:0]	FSB Frequency Select	001 = FSB533 011 = FSB667 010 = FSB800 others = Reserved
CFG[4:3]	Reserved	
CFG5	DMI x2 Select	0 = DMI x2 1 = DMI x4 (Default)
CFG[8:6]	Reserved	
	Low Power PCI Express	0 = Normal mode 1 = Low Power mode (Default)
CFG9	PCI Express Graphics Lane Reversal	0 = Reverse Lanes,15->0,14->1 ect.. 1= Normal operation(Default):Lane Numbered in order
CFG[11:10]	Reserved	
CFG[13:12]	XOR/ALL Z test straps	00 = Reserved 01 = XOR mode enabled 10 = All Z mode enabled 11 = Normal Operation (Default)
CFG[15:14]	Reserved	Reserved
CFG16	FSB Dynamic ODT	0 = Dynamic ODT Disabled 1 = Dynamic ODT Enabled (Default)
CFG[18:17]	Reserved	
CFG19	DMI Lane Reversal	0 = Normal operation (Default):lane Numbered in order 1 =Reverse Lane,4->0,3->1 ect...
CFG20	SDVO/PCIE Concurrent	0 = Only SDVO or PCIE x1 is operational (Default) 1 =SDVO and PCIE x1 are operating simultaneously via the PEG port
SDVOCRTL _DATA	SDVO Present	0 = No SDVO Card present (Default) 1= SDVO Card present

NOTE: All strap signals are sampled with respect to the leading
edge of the Crestline GMCH FWORK in signal.

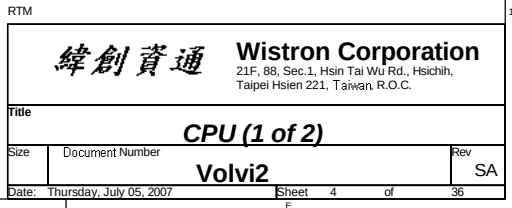
History

2007/05/02
1 Based on Tahoe to modify schematics.
=====

2007/05/14
1. Page 34: Replace "D25" with "BAS16-1-GP".
2. Page 27: Replace "R485" with "2K7R2j".
3. Page 27: DY: C379"
4. Page 27: Add "C682" D1u capacitor on "L1D1.PIN1"
5. Page 27: Replace "R238" with "0R2".
6. Page 25: Replace "INTMIC1" & "SPKR1" with main source follow connector list.
7. Page 5: Add C115, C116, C141, C149, C169, C171 for Colay with TC25.
8. Page 10: Replace "L20" with "68.00217.141".
9. Page 10: Replace "L10" & "L23" with "68.00217.101"
=====

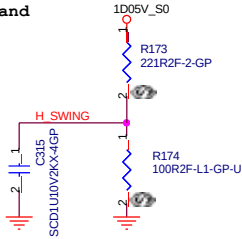
RTM

緯創資通 Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan R.O.C.		
Title Reference		
Size A3	Document Number Volvi2	Rev -1
Date: Thursday, July 05, 2007 Sheet 2 of 36		

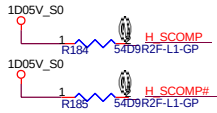


H_SWING routing Trace width and Spacing use 10 / 20 mil

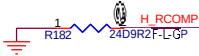
H_SWING Resistors and Capacitors close MCH 500 mil (MAX)



H_SCOMP and H_SCOMP# Resistors and Capacitors close MCH 500 mil (MAX)

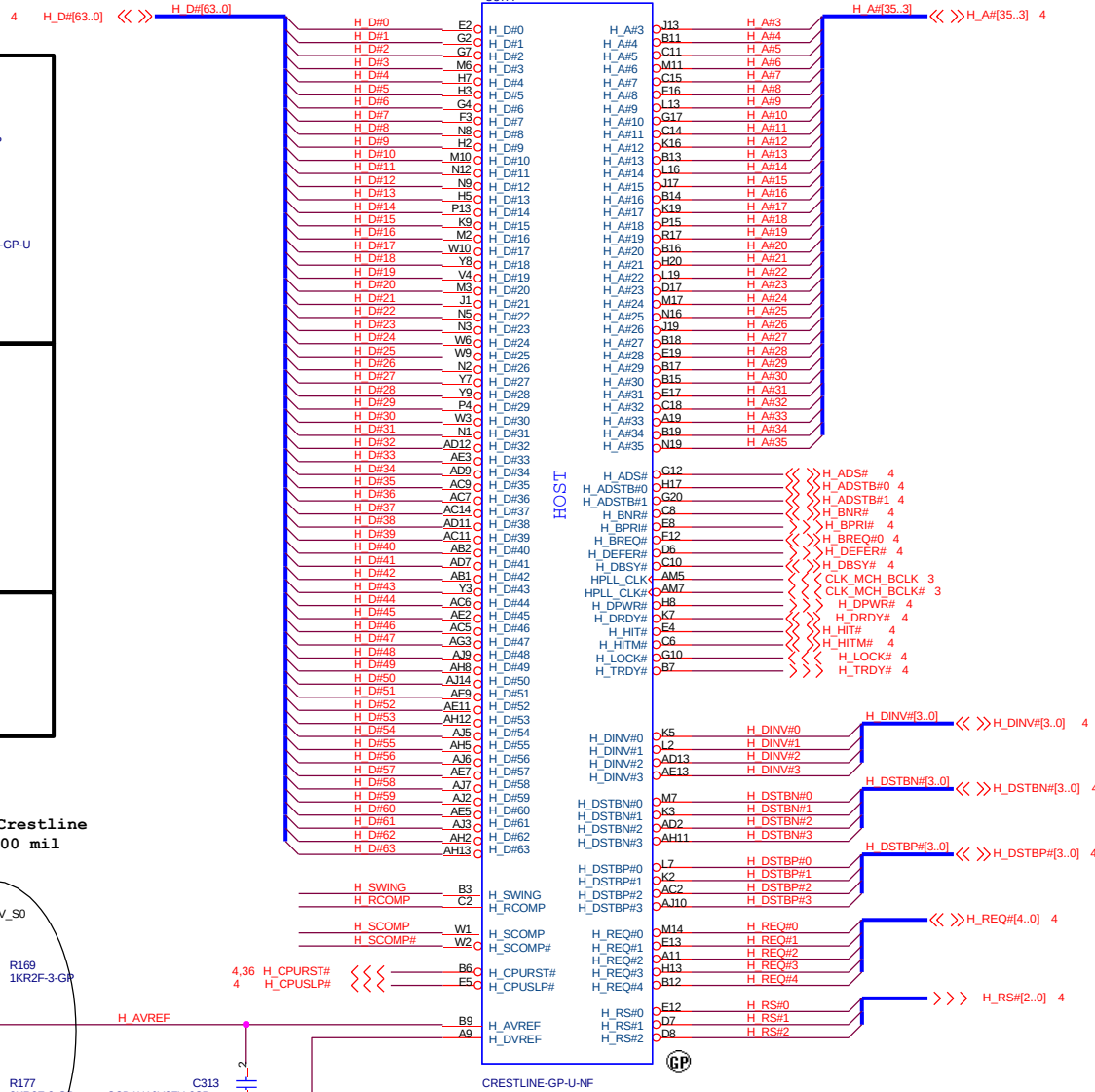
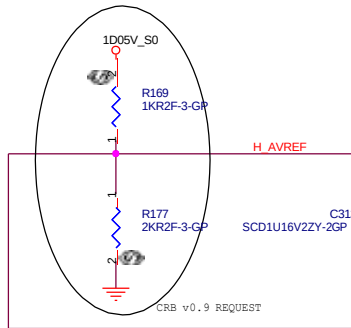


H_RCOMP routing Trace width and Spacing use 10 / 20 mil



Place them near to the chip (< 0.5")

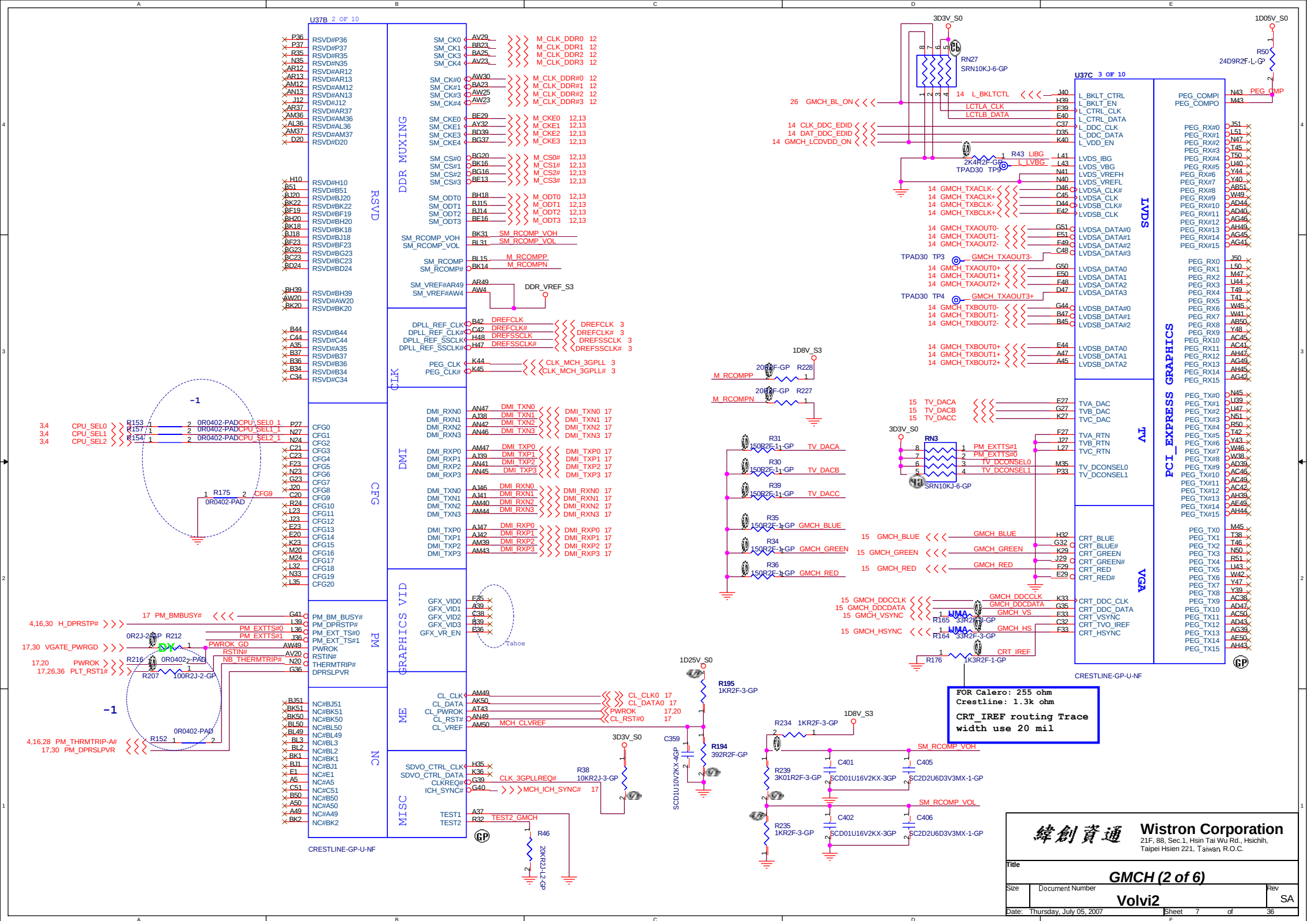
H_REF Decoupling Crestline close Crestline 100 mil

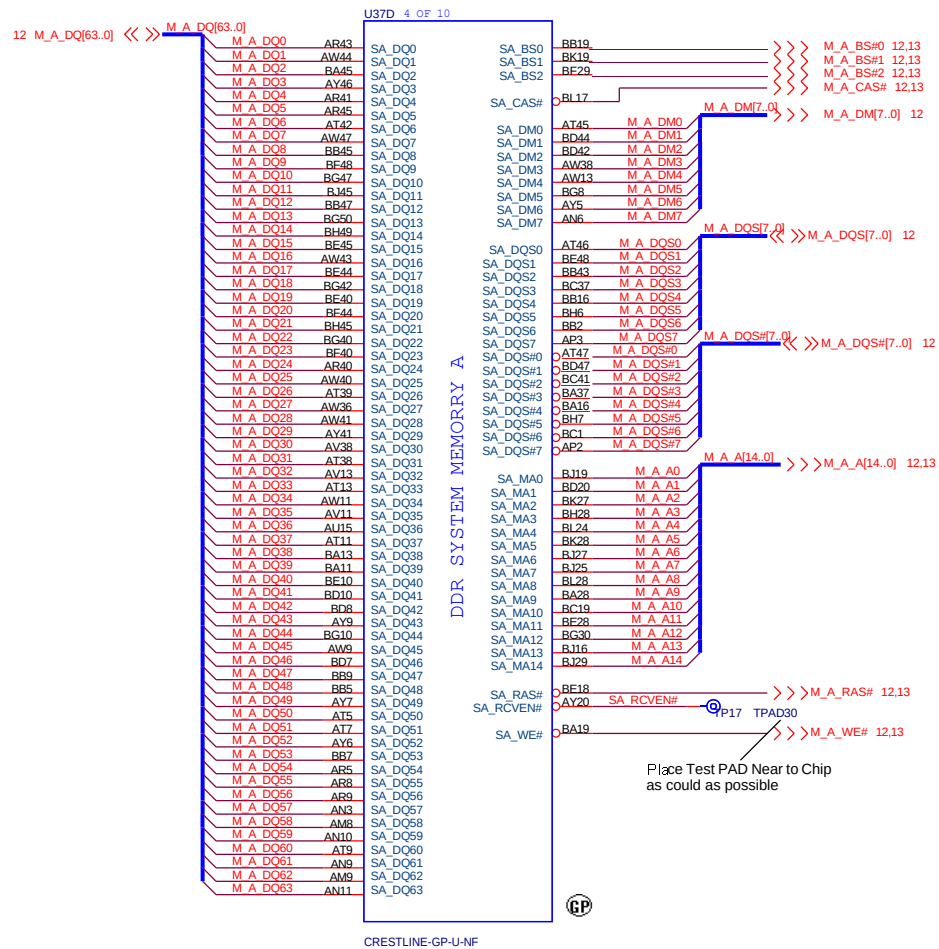


RTM

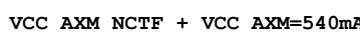
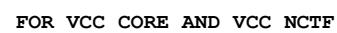
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Taipei Hsien 221, Taiwan, R.O.C.

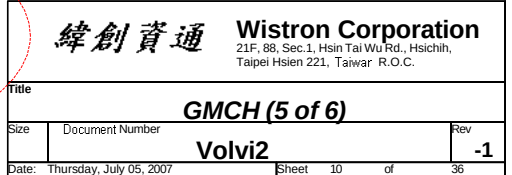
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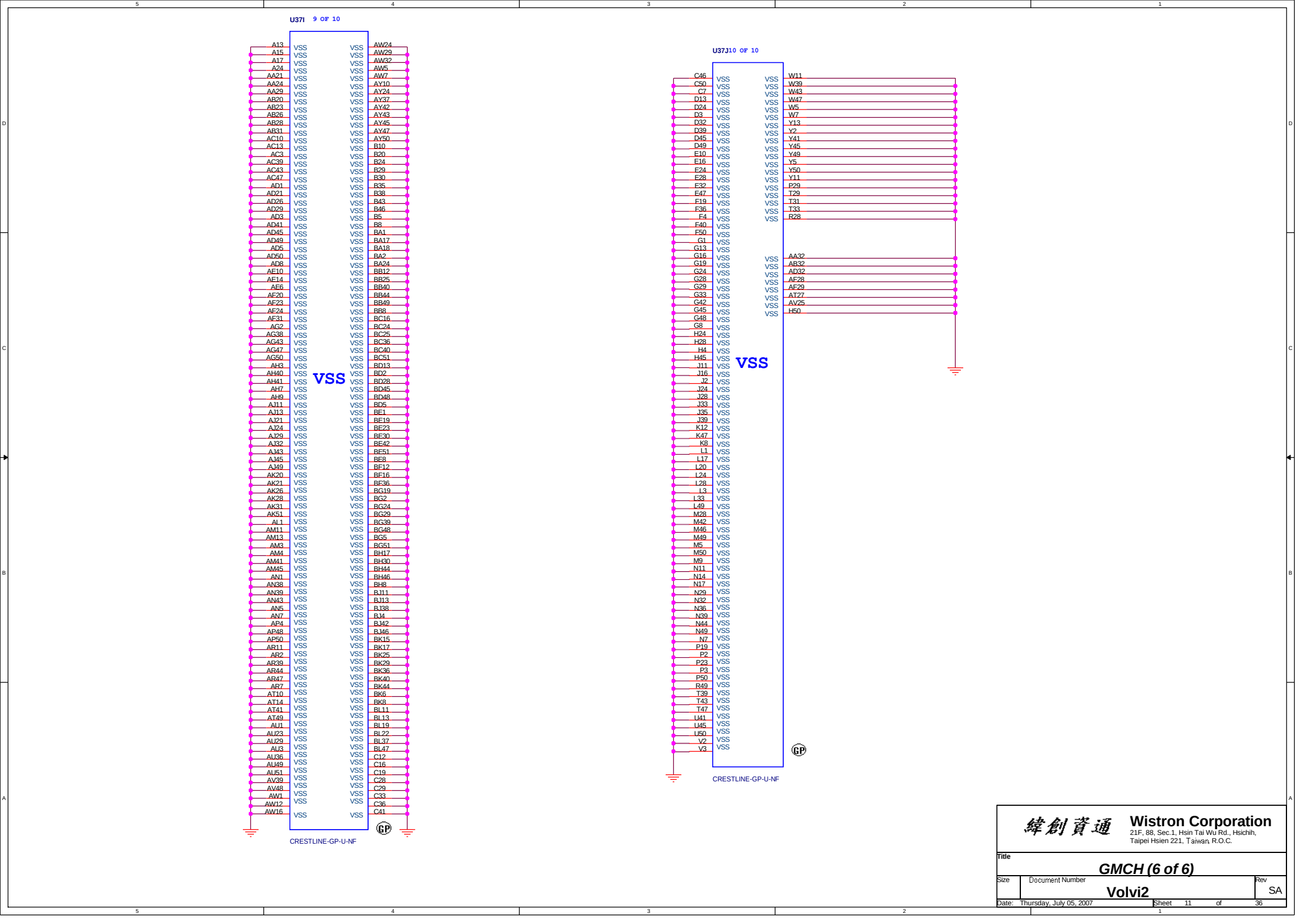




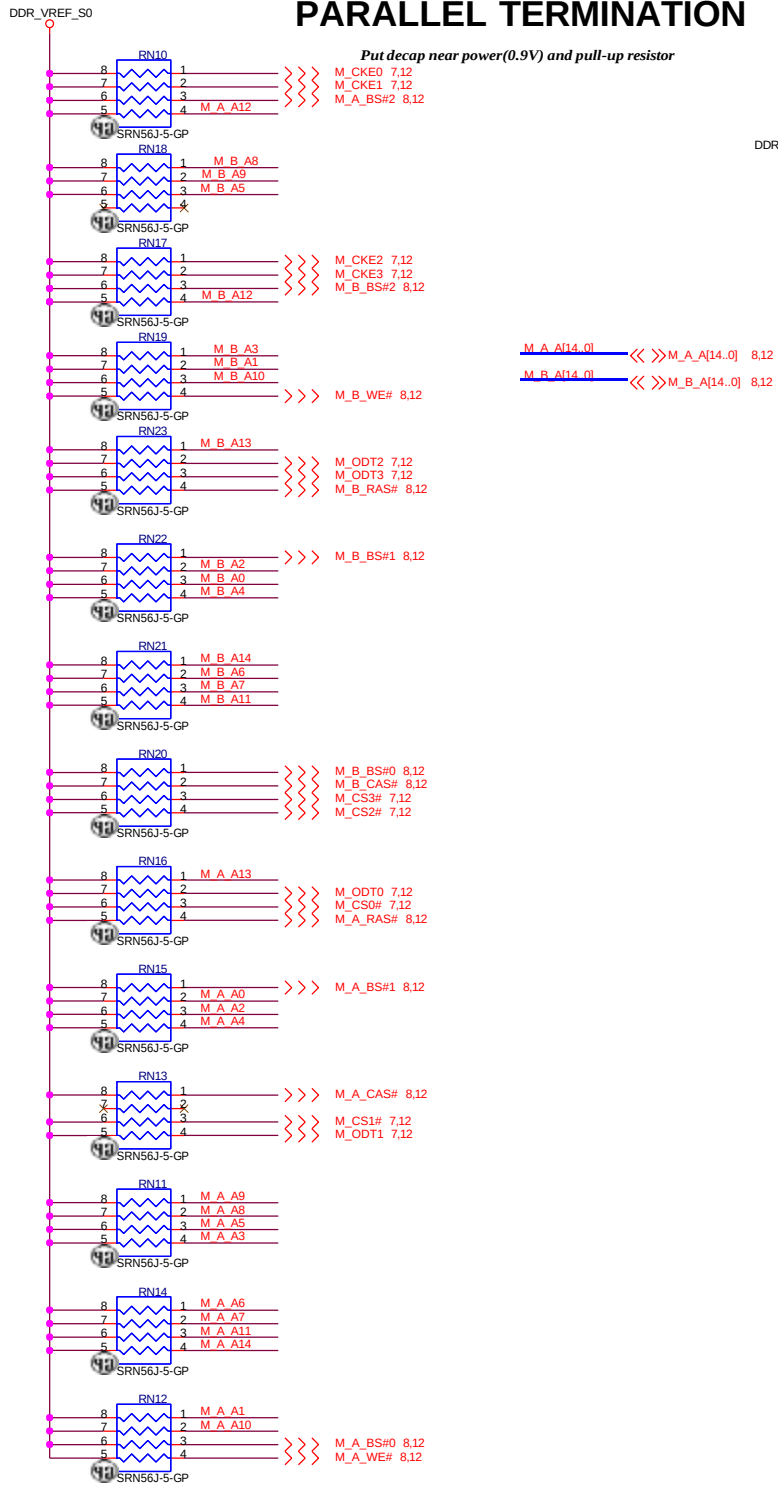
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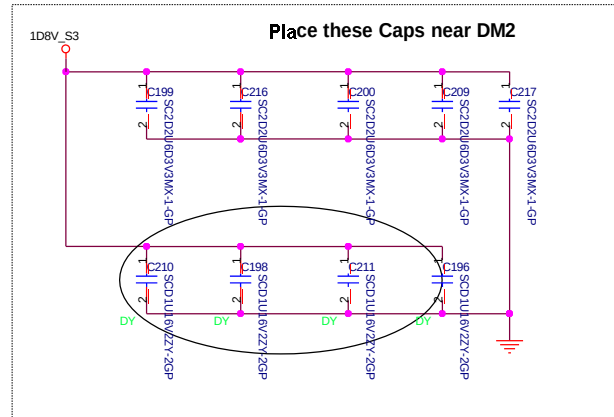
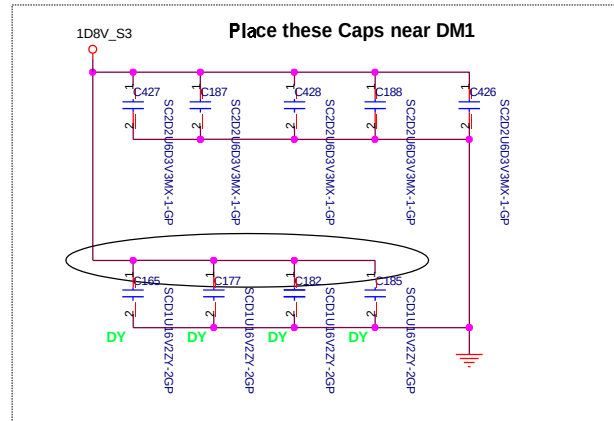
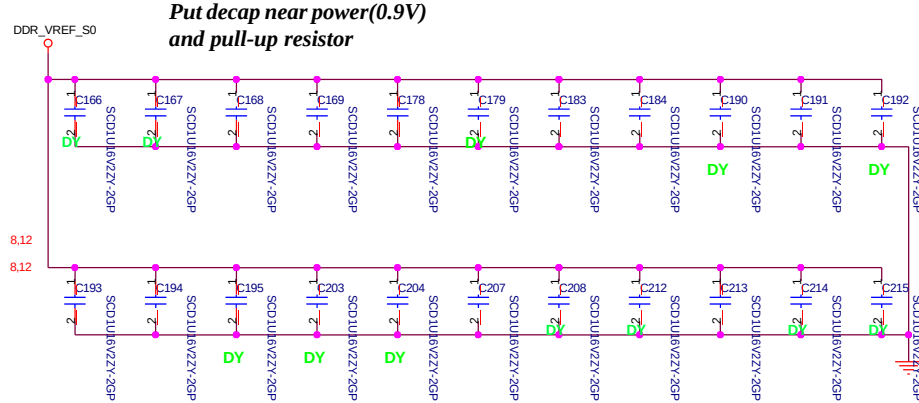




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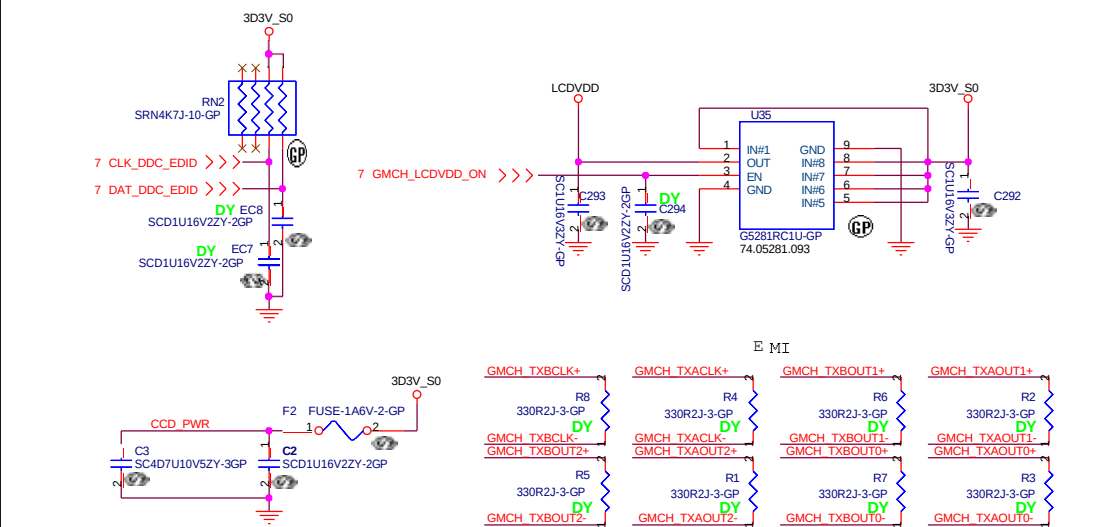
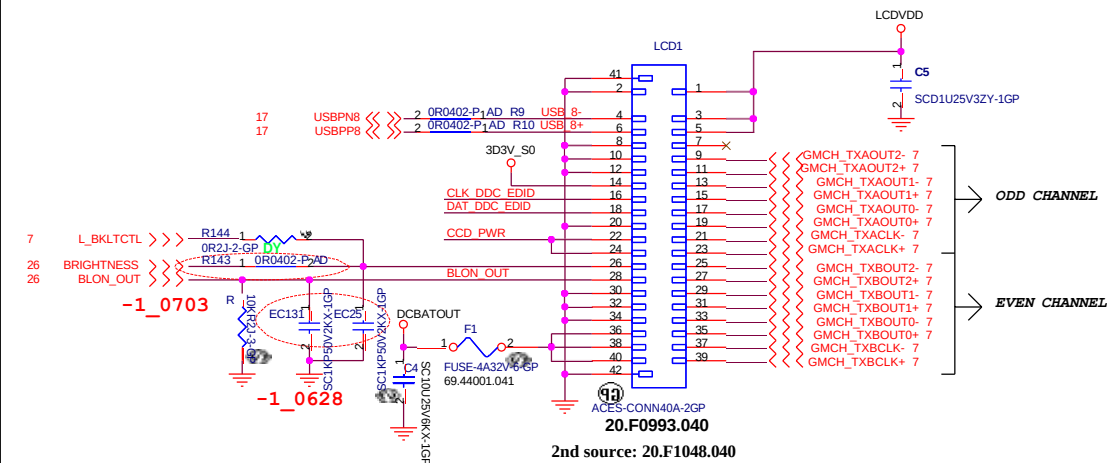


Decoupling Capacitor

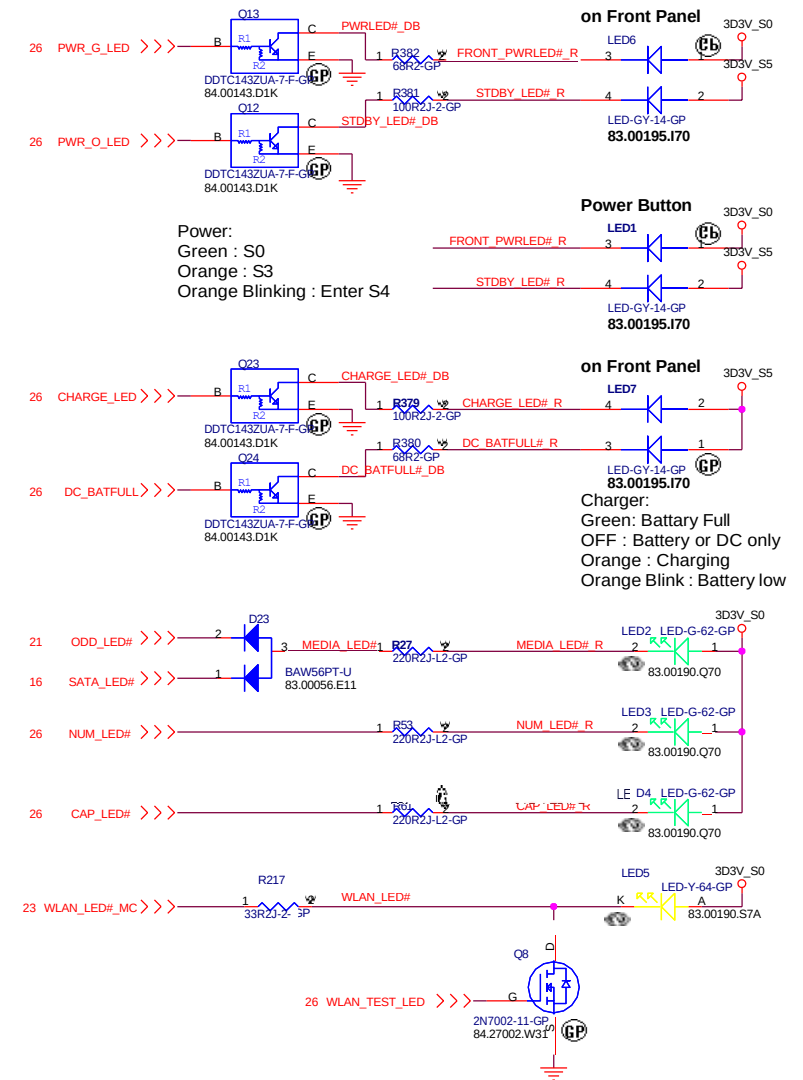
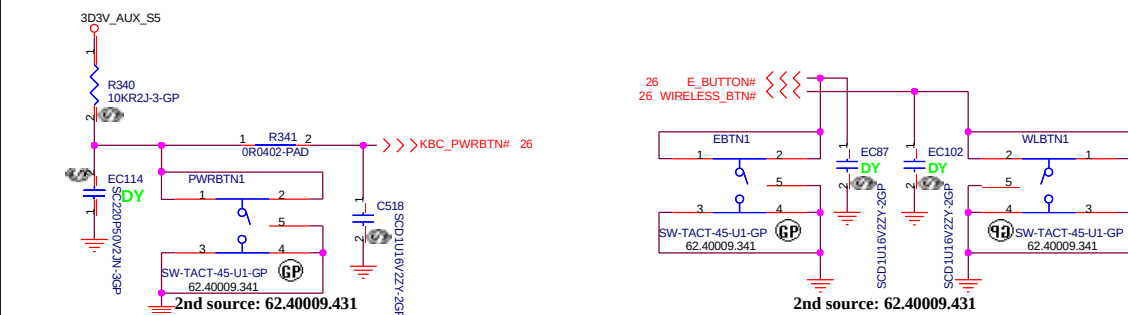


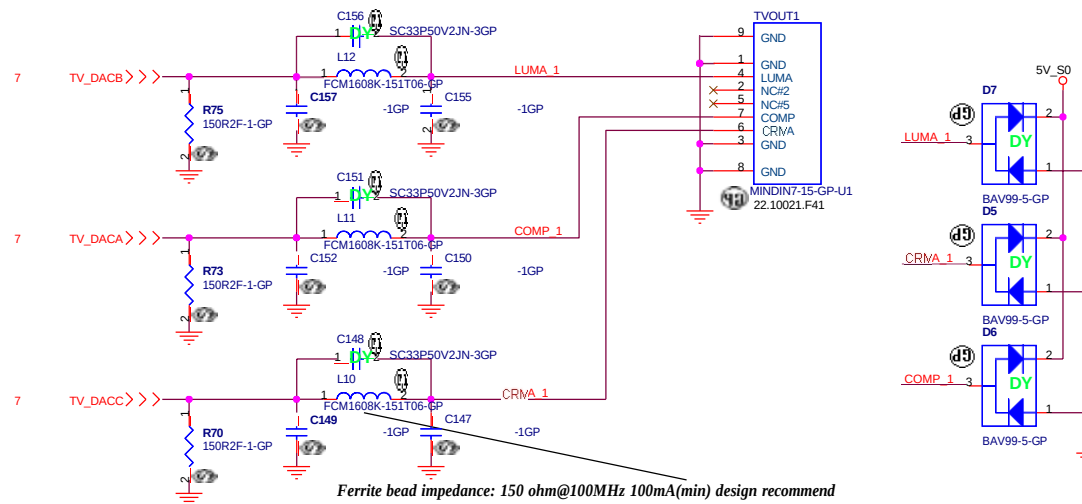
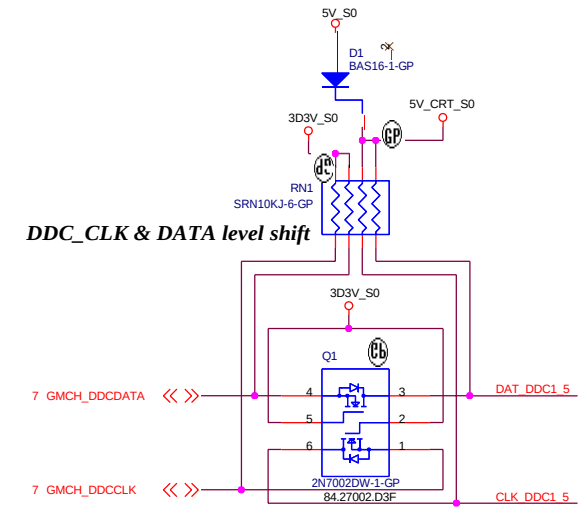
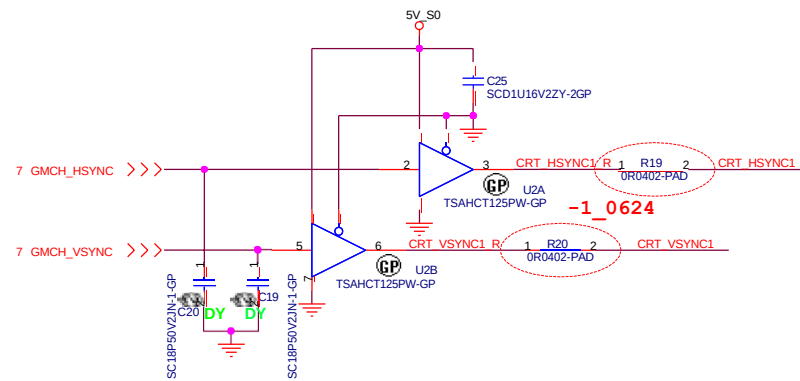
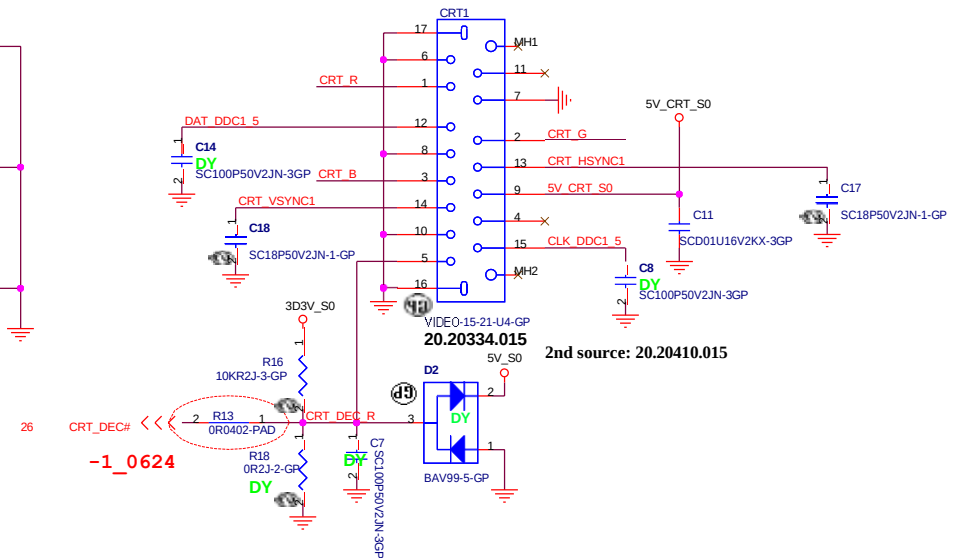
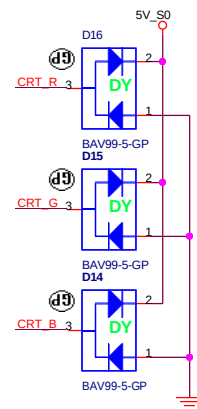
LCD/INVERTER CONN

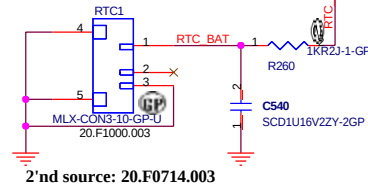
LED



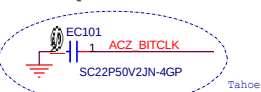
Buttons



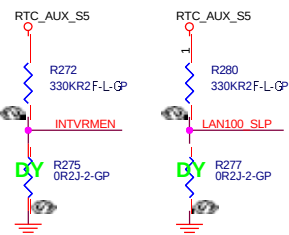
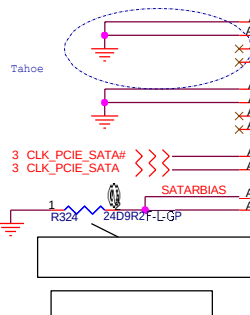




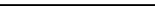
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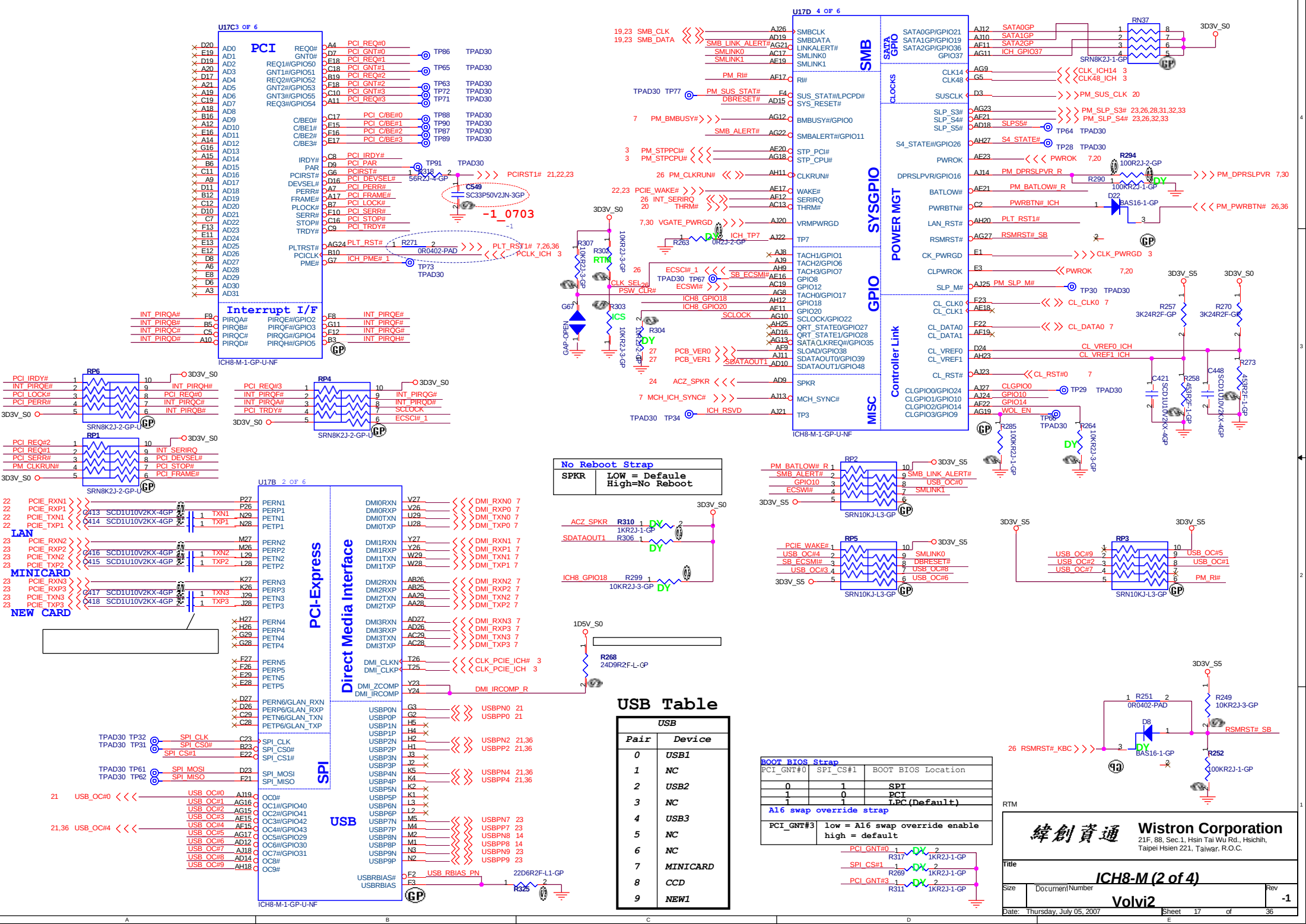


Tahoe

[illegible]

integrated VccSus1_05,VccSus1_5,VccCl1_5	
INTVRMEN	High=Enable Low=Disable
integrated VccLan1_05VccCl1_05	
LAN100_SLP	High=Enable Low=Disable

RTM	
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Title	
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SA	



No Reboot Strap
SPKR LOW = Default
High=No Reboot

USB Table

USB	
Pair	Device
0	USB1
1	NC
2	USB2
3	NC
4	USB3
5	NC
6	NC
7	MINICARD
8	CCD
9	NEW1

BOOT BIOS Strap		
PCI_GNT#0	SPI_CS#1	BOOT BIOS Location
0	1	SPI
1	0	PCT
1	1	LPC(Default)

A16 swap override strap

PCI_GNT#3	low = A16 swap override enable high = default
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Title		
ICH8-M (2 of 4)		
Size	DocumenjNumber	Rev
		-1
Date: Thursday, July 05, 2007		
Sheet	17	of 36

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